



Material Content Data Sheet



Sales Product Name				SAL-TC389QP-160F300S AD		Issued		30. July 2019	
MA#				MA003883546					
Package				PG-FBGA-516-1		Weight*		2092.39 mg	
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]	
chip	inorganic material	silicon	7440-21-3	26.579	1.27	1.27	12703	12703	
wire	noble metal	palladium	7440-05-3	0.027	0.00		13		
	non noble metal	copper	7440-50-8	2.629	0.13	0.13	1257	1270	
encapsulation	organic material	carbon black	1333-86-4	1.573	0.08		752		
	plastics	epoxy resin	-	108.544	5.19		51875		
	inorganic material	silicondioxide	60676-86-0	676.432	32.33	37.60	323282	375909	
substrate	inorganic material	bariumsulfate	7727-43-7	22.732	1.09		10864		
	plastics	acrylic resin	-	26.308	1.26		12573		
	non noble metal	metal hydroxide	-	31.008	1.48		14819		
	inorganic material	amorphous silica	7631-86-9	62.016	2.96		29639		
	plastics	epoxy resin	-	107.838	5.15		51538		
	inorganic material	glass fibre wool	65997-17-3	124.031	5.93		59277		
	non noble metal	copper	7440-50-8	696.056	33.25	51.12	332660	511370	
plating	noble metal	gold	7440-57-5	1.985	0.09		949		
	non noble metal	nickel	7440-02-0	5.432	0.26	0.35	2596	3545	
solderball	noble metal	silver	7440-22-4	6.821	0.33		3260		
	non noble metal	tin	7440-31-5	188.053	8.99	9.32	89875	93135	
glue	plastics	epoxy resin	-	1.082	0.05		517		
	noble metal	silver	7440-22-4	3.246	0.16	0.21	1551	2068	
*deviation	< 10%					Sum in total:	100.00	1000000	

Important Remarks:

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This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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